



3.3V PCI Express[®] 3.0 4 Channel 2x2 Exchange Switch

Features

- → 4 Differential Channel 2x2 Exchange Switch
- → PCI Express[®] 3.0 performance, 8.0 Gbps
- → Bi-directional operation
- → Low Bit-to-Bit Skew: 10ps (between ± signals)
- → Low Crosstalk: -29dB @ 2.5GHz (5Gbps) -20dB @ 4.0GHz (8Gbps)
- → Low Insertion Loss: -1.1dB @ 2.5GHz (5Gbps) -1.45dB @ 4.0GHz (8Gbps)
- → V_{DD} Operating Range: 3.3V ±10%
- → Industrial Temperature Range: -40°C to 85°C
- → ESD Tolerance: 2kV HBM
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

- → Packaging (Pb-free & Green):
 - ^o 30-contact, TQFN (ZL30), 2.5 x 4.5mm.

Description

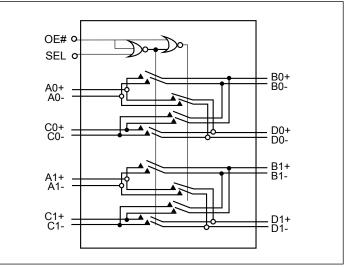
The PI3PCIE3242A is a differential exchange switch featuring pass-through pinout. It supports one full PCI Express[®] lane 2x2 Exchange Switch operating at 8.0Gbps PCIe[®] 3.0 performance.

With the select control input low, Port A connects to Port B, and Port C connects to port D for an 8-channel differential passthough. When the select control input is high Port A connects to Port D, and Port B connects to Port C.

Truth Table

Function	SEL	OE#
Ax = Bx $Cx = Dx$	0	0
Ax = Dx $Cx = Bx$	1	0
Ax, Bx, Cx, Dx = Hi-Z (disconnect)	х	1

Block Diagram



Notes:

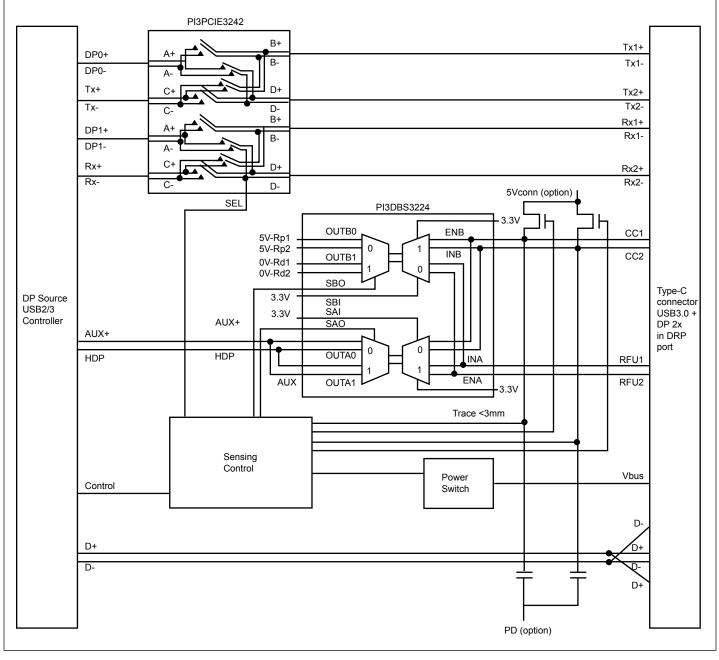
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

^{1.} No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.





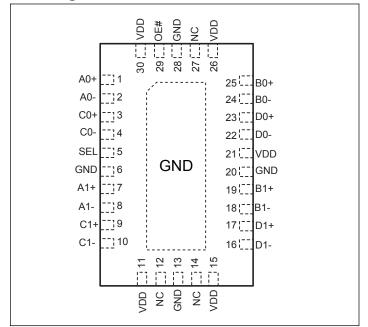
Application Diagram in Switching 2 Lanes of DP1.2 & USB 3.0 Signals Over Type C Connector Notebook or Tablet







Pin Diagram



Pin Description

Pin #	Pin Name	I/O	Description
1, 2	A0+, A0–	I/O	Signal I/O, Channel 0, Port A
7, 8	A1+, A1–	I/O	Signal I/O, Channel 1, Port A
25, 24	B0+, B0–	I/O	Signal I/O, Channel 0, Port B
19, 18	B1+, B1–	I/O	Signal I/O, Channel 1, Port B
3, 4	C0+, C0-	I/O	Signal I/O, Channel 0, Port C
9, 10	C1+, C1–	I/O	Signal I/O, Channel 1, Port C
23, 22	D0+, D0-	I/O	Signal I/O, Channel 0, Port D
17, 16	D1+, D1–	I/O	Signal I/O, Channel 1, Port D
29	OE#	Ι	Output Enable, active low. When OE# = 0 the device I/O is enabled. When OE#=1, all I/O are high impedance
5	SEL	Ι	Operation mode Select (when SEL=0: $A \rightarrow B$, $C \rightarrow D$, when SEL=1: $A \rightarrow D$, $C \rightarrow B$)
11, 15, 21, 26, 30	V _{DD}	Pwr	3.3V ±10% Positive Supply Voltage
6, 13, 20, 28, Center Pad	GND	Pwr	Power ground
12, 14, 27	NC		No Connect



Note:



PI3PCIE3242A

Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature65°C to +150	°C
Supply Voltage to Ground Potential0.5V to +3.	
DC Input Voltage0.5V to V	DD
DC Output Current	nA
Power Dissipation	W
Junction Temperature	°C

Stresses greater than those listed under MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics Recommended Operating Conditions

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{DD}	3.3V Power Supply		3.0	3.3	3.6	V
I _{DD}	Total current from V_{DD} 3.3V supply	SEL and OE# at OV or $\rm V_{DD}$			200	μΑ
T _A	Operating temperature range		-40		85	°C

DC Electrical Characteristics for Switching over Operating Range

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽¹⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed HIGH level	0.65 x V _{DD}			
V _{IL}	Input LOW Voltage	Guaranteed LOW level	-0.5		0.35 x V _{DD}	V
V _{IK}	Clamp Diode Voltage	$V_{DD} = Max., I_{IN} = -18mA$		-0.7	-1.2	
I _{IH}	Input HIGH Current, SEL	V_{DD} = Max., V_{IN} = V_{DD}	-10		+10	
I _{IL}	Input LOW Current, SEL	V _{DD} = Max., V _{IN} = GND	-10		+10	μΑ
IIH	Input HIGH Current, A _X , B _X , C _X , D _X	$V_{DD} = Max., V_{IN} = 1.8V$	-10		+10	
IIL	Input LOW Current, A _X , B _X , C _X , D _X	$V_{DD} = Max., V_{IN} = 0V$	-10		μA +10	

Note:

1. Typical values are at VDD = 3.3V, TA = 25°C ambient and maximum loading.

Switching Characteristics

Parameters	Description	Test Conditions	Min.	Тур.	Max.	Units
t _{PZH} , t _{PZL}	Line Enable Time - SEL to A_N , B_N , C_N , D_N		0.5		45	
t _{PHZ} , t _{PLZ}	Line Disable Time - SEL to A_N , B_N , C_N , D_N		0.5		25	ns
t _{b-b}	Bit-to-bit skew within the same differential pair		10			
t _{ch-ch}	hannel-to-channel skew		20	ps		





Dynamic Electrical Characteristics

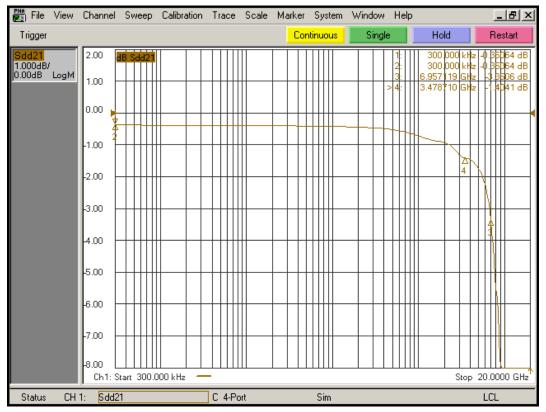
Parameter	Description	Test Conditions	Min.	Typ. ⁽¹⁾	Max.	Units
		f=1.2GHz		-0.8	-1.0	
		f=2.5GHz		-1.0	-1.2	
DDIL	Differential Insertion Loss	f=4.0GHz		-1.3	-1.9	dB
	$(V_{IN} = -10 dBm, DC = 0V)$	f=5.0GHz		-1.8	-2.6	
		f=7.5GHz		-4.5	-5.6	
DDIL	Differential Off Isolation	f= 4.0GHz		-19		dB
		f= 0 to 2.8GHz		-26		
DDRL	Differential Return Loss	f= 2.8 to 5.0GHz		-14		dB
		f= 5.0 to 8.0GHz		-7.5		
	Near End Crosstalk	f= 0 to 2.8GHz		-26		
DDNEXT		f= 2.8 to 5.0GHz		-20		dB
		f= 5.0 to 8.0GHz		-16		
		Insertion loss 1.5dB, V _{IN} =0.623Vpp, DC=0V		4.0		
V _{IF}	Max Signal Frequency Range	Insertion loss 1.5dB, V _{IN} =0.623Vpp, DC=0.9V		4.0		
		Insertion loss 3dB, V _{IN} =0.623Vpp, DC=0V		8.0		GHz
		Insertion loss 3dB, V _{IN} =0.623Vpp, DC=0.9V		8.0		
BW	-3dB Bandwidth			6.5		GHz

Notes:

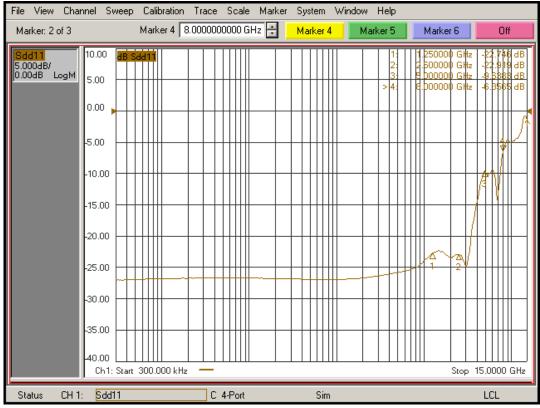
1. Guaranteed by design. Typical values are at $\rm V_{DD}$ = 3.3V , $\rm T_A$ = 25°C ambient and maximum loading.







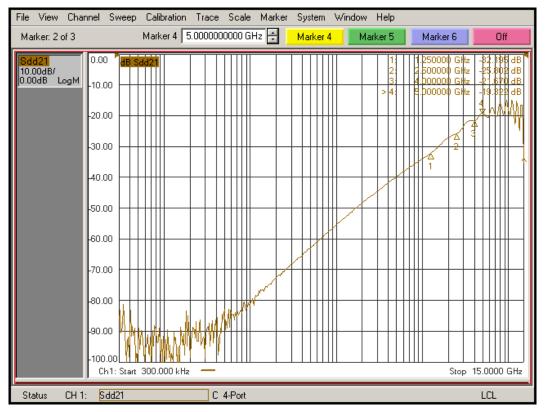
Differential Insertion Loss



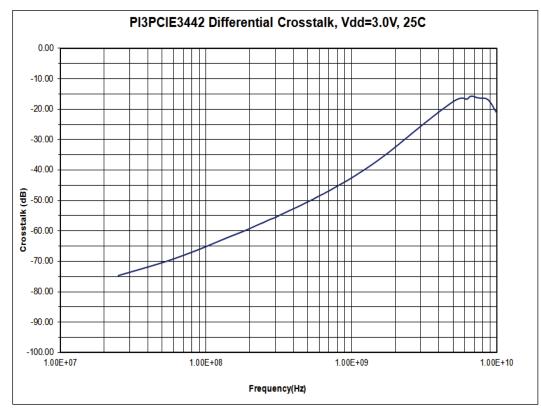
Differential Return Loss







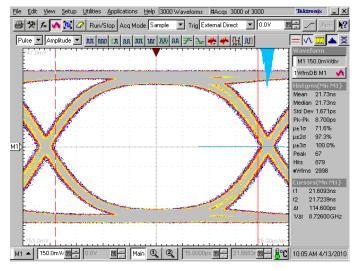
Differential Off Isolation



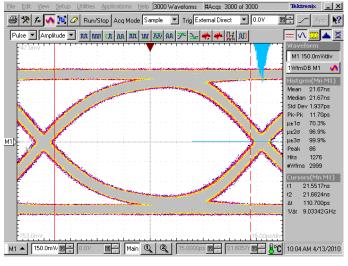
Differential Crosstalk



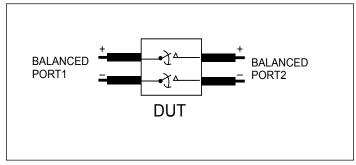




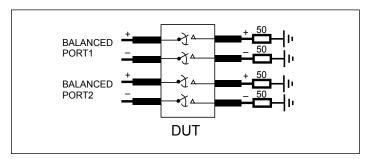
8.0 Gbps RX signal eye without PI3PCIE3242A



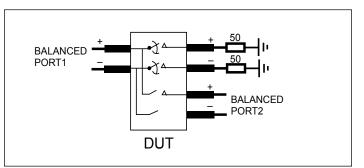
8.0 Gbps RX signal eye with PI3PCIE3242A



Differential Insertion Loss and Return Test Circuit



Differential Near End Xtalk Test Circuit

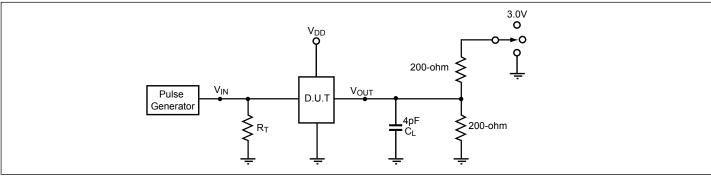


Differential Off Isolation Test Circuit





Test Circuit for Electrical Characteristics



Notes:

1. C_L = Load capacitance: includes jig and probe capacitance.

2. RT = Termination resistance: should be equal to ZOUT of the Pulse Generator

3. Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

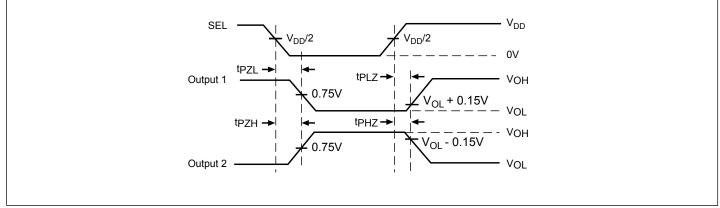
4. All input impulses are supplied by generators having the following characteristics: $PRR \le MHz$, $Z_O = 50\Omega$, $t_R \le 2.5ns$, $t_F \le 2.5ns$.

5. The outputs are measured one at a time with one transition per measurement.

Switch Positions

Test	Switch
t_{PLZ}, t_{PZL}	3.0V
t _{PHZ} , t _{PZH}	GND
Prop Delay	Open

Switching Waveforms



Voltage Waveforms Enable and Disable Times

Part Marking

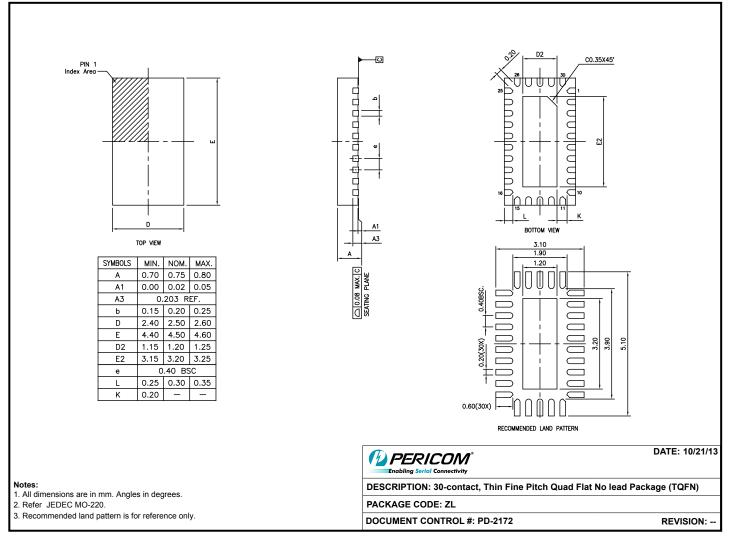


YY : Year WW : Workweek 1st X: Assembly Code 2nd X: Fab Code









14-0006

For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Code	Package Code	Package Description
PI3PCIE3242AZLEX	ZL	30-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN)

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm

antimony compounds.

4. E = Pb-free and Green

5. X suffix = Tape/Reel





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